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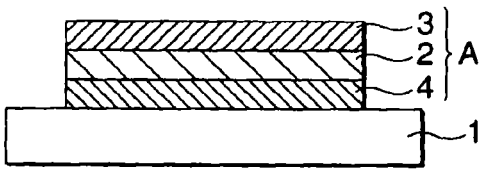
(54) Title: LABEL SHEET FOR CLEANING AND CONVEYING MEMBER HAVING CLEANING FUNCTION



(57) Abstract: A label sheet for cleaning is formed of a label (A) for cleaning including a cleaning layer (3) having a 180° peeling adhesion to a silicon wafer of 0.20 N/10 mm or less after receiving an active energy and an adhesive layer (4) provided on one of surfaces of said cleaning layer (3), and a separator (1) on which the label (A) is removably provided through the adhesive layer (4).

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